

December 1996

**Fast CMOS Quad 2-Input Multiplexers**
**Features**

- Advanced 0.8 micron CMOS Technology
- These Devices are Pin Compatible with Bipolar FAST™ Series at a Higher Speed and Lower Power Consumption
- 25Ω Series Resistor On All Outputs (FCT2XXX Only)
- TTL Input and Output Levels
- Low Ground Bounce Outputs (25Ω Series Only)
- Extremely Low Static Power
- Hysteresis on All Inputs

**Ordering Information**

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
CD74FCT157TM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT157ATM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT157CTM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT157DTM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT157TNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT157ATNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT157CTNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT157DTNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT157TQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT157ATQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT157CTQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT157DTQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT257TM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT257ATM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT257CTM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT257TNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT257ATNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT257CTNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT257DTNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT257TQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT257ATQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT257CTQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT257DTQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT2157TM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2157ATM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2157CTM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2157TNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2157ATNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2157CTNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2157DTNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2157TQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT2157ATQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT2157CTQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT2157DTQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT2257TM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2257ATM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2257CTM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2257TNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2257ATNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2257CTNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2257DTNM	-40 to 85	16 Ld SOIC	M16.3-P
CD74FCT2257TQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT2257ATQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT2257CTQM	-40 to 85	16 Ld QSOP	M16.15A-P
CD74FCT2257DTQM	-40 to 85	16 Ld QSOP	M16.15A-P

NOTE: When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.

**Description**

These devices are high-speed quad 2-input multiplexers. The common select input can be used to select four bits of data from two sources. The four buffered outputs present the selected data in the true (non-inverting) form.

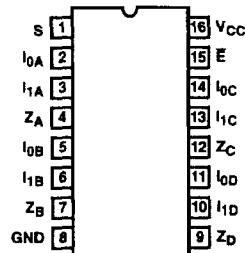
The CD74FCT157T and CD74FCT2157T have a common, active-LOW, Enable input ( $\bar{E}$ ). When  $\bar{E}$  is inactive, all four outputs are held LOW. The CD74FCT157T and CD74FCT2157T can generate any four of the 16 different functions of two variables with one common variable. They can be used as a function generator or to move data from two different groups of registers to a common bus.

The CD74FCT257T and CD74FCT2257T have a common Output Enable ( $\bar{OE}$ ) input. When  $\bar{OE}$  is HIGH, all outputs are switched to a high-impedance state allowing the outputs to interface directly with bus-oriented systems.

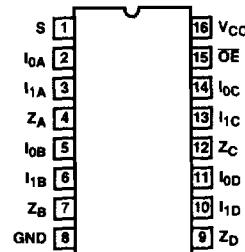
The CD74FCT2157T and CD74FCT2257T devices have a built-in 25Ω series resistor on all outputs to reduce noise due to reflections, thus eliminating the need for an external terminating resistor.

**Pinout**
**CD74FCT157T, 7CD74FCT2157T  
(QSOP, SOIC)**

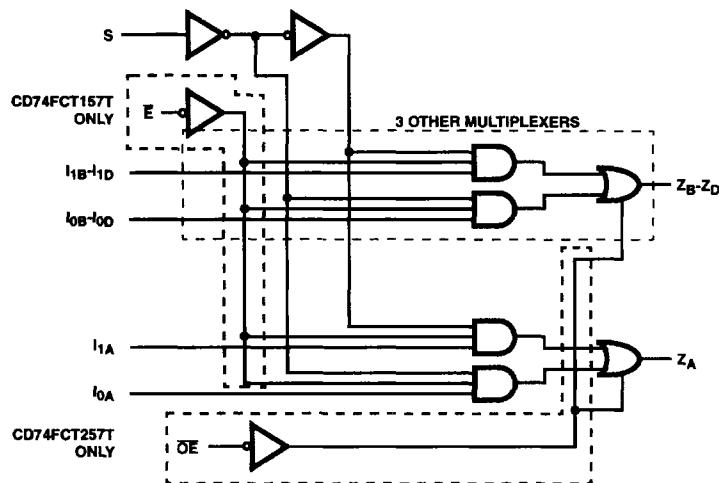
TOP VIEW


**CD74FCT257T, 7CD74FCT2257T  
(QSOP, SOIC)**

TOP VIEW



**Functional Block Diagram**



**TRUTH TABLE (NOTE 1)**

INPUTS				OUTPUTS $Z_N$	
$\bar{E}/\bar{O}E$	S	$I_0$	$I_1$	CD74FCT157T, CD74FCT2157T	CD74FCT257T, CD74FCT2257T
H	X	X	X	L	Z
L	H	X	L	L	L
L	H	X	H	H	H
L	L	L	X	L	L
L	L	H	X	H	H

**NOTE:**

1. H = High Voltage Level
- L = Low Voltage Level
- X = Don't Care
- Z = High Impedance

**Pin Descriptions**

PIN NAME	DESCRIPTION
$I_0A-I_0D$	Source 0 Data Inputs
$I_1A-I_1D$	Source 1 Data Inputs
$\bar{E}$	Enable Input (Active LOW) CD74FCT157T, CD74FCT2157T
$\bar{O}E$	Output Enable (Active LOW) CD74FCT257T, CD74FCT2257T
S	Select Input
$Z_A-Z_D$	Outputs
GND	Ground
V <sub>CC</sub>	Power

**Absolute Maximum Ratings**

DC Input Voltage .....	-0.5V to 7.0V
DC Output Current .....	120mA

**Operating Conditions**

Operating Temperature Range .....	-40°C to 85°C
Supply Voltage to Ground Potential .....	
Inputs and V <sub>CC</sub> Only .....	-0.5V to 7.0V
Supply Voltage to Ground Potential .....	
Outputs and D/O Only .....	-0.5V to 7.0V

*CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.*

NOTE:

2. θ<sub>JA</sub> is measured with the component mounted on an evaluation PC board in free air.

**Thermal Information**

Thermal Resistance (Typical, Note 2) .....	θ <sub>JA</sub> (°C/W)
SOIC Package .....	97
QSOP Package .....	140
Maximum Junction Temperature .....	150°C
Maximum Storage Temperature Range .....	-65°C to 150°C
Maximum Lead Temperature (Soldering 10s) .....	300°C
(Lead Tips Only)	

**Electrical Specifications**

PARAMETER	SYMBOL	(NOTE 3) TEST CONDITIONS	MIN	(NOTE 4) TYP	MAX	UNITS	
<b>DC ELECTRICAL SPECIFICATIONS</b> Over the Operating Range, T <sub>A</sub> = -40°C to 85°C, V <sub>CC</sub> = 5.0V ±5%							
Output HIGH Voltage	V <sub>OH</sub>	V <sub>CC</sub> = Min, V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -15.0mA	2.4	3.0	-	V
Output LOW Voltage	V <sub>OL</sub>	V <sub>CC</sub> = Min, V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 48mA	-	0.3	0.50	V
Output LOW Voltage	V <sub>OL</sub>	V <sub>CC</sub> = Min, V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 12mA (25Ω series)	-	0.3	0.50	V
Input HIGH Voltage	V <sub>IH</sub>	Guaranteed Logic HIGH Level		2.0	-	-	V
Input LOW Voltage	V <sub>IL</sub>	Guaranteed Logic LOW Level		-	-	0.8	V
Input HIGH Current	I <sub>IH</sub>	V <sub>CC</sub> = Max	V <sub>IN</sub> = V <sub>CC</sub>	-	-	1	μA
Input LOW Current	I <sub>IL</sub>	V <sub>CC</sub> = Max	V <sub>IN</sub> = GND	-	-	-1	μA
High Impedance Output Current	I <sub>OZH</sub>	V <sub>CC</sub> = Max	V <sub>OUT</sub> = 2.7V		1	μA	
	I <sub>OZL</sub>		V <sub>OUT</sub> = 0.5V		-1	μA	
Clamp Diode Voltage	V <sub>IK</sub>	V <sub>CC</sub> = Min, I <sub>IN</sub> = -18mA		-	-0.7	-1.2	V
Short Circuit Current	I <sub>OS</sub>	V <sub>CC</sub> = Max (Note 5), V <sub>OUT</sub> = GND		-60	-120	-	mA
Power Down Disable	I <sub>OFF</sub>	V <sub>CC</sub> = GND, V <sub>OUT</sub> = 4.5V		-	-	100	μA
Input Hysteresis	V <sub>H</sub>			-	200	-	mV
<b>CAPACITANCE</b> T <sub>A</sub> = 25°C, f = 1MHz							
Input Capacitance (Note 6)	C <sub>IN</sub>	V <sub>IN</sub> = 0V		-	6	10	pF
Output Capacitance (Note 6)	C <sub>OUT</sub>	V <sub>OUT</sub> = 0V		-	8	12	pF
<b>POWER SUPPLY SPECIFICATIONS</b>							
Quiescent Power Supply Current	I <sub>CC</sub>	V <sub>CC</sub> = Max	V <sub>IN</sub> = GND or V <sub>CC</sub>	-	0.1	500	μA
Supply Current per Input at TTL HIGH	ΔI <sub>CC</sub>	V <sub>CC</sub> = Max	V <sub>IN</sub> = 3.4V (Note 7)	-	0.5	2.5	mA
Supply Current per Input per MHz (Note 8)	I <sub>CCD</sub>	V <sub>CC</sub> = Max, Outputs Open E or OE = GND One Bit Toggling 50% Duty Cycle	V <sub>IN</sub> = V <sub>CC</sub> V <sub>IN</sub> = GND	-	0.15	0.25	mA/ MHz

# CD74FCT157T, CD74FCT257T, CD74FCT2157T, CD74FCT2257T

## Electrical Specifications (Continued)

PARAMETER	SYMBOL	(NOTE 3) TEST CONDITIONS				MIN	(NOTE 4) TYP	MAX	UNITS
		V <sub>CC</sub> = Max, Outputs Open f <sub>I</sub> = 10MHz, 50% Duty Cycle E or OE = GND One Bit Toggling	V <sub>IN</sub> = V <sub>CC</sub> V <sub>IN</sub> = GND	V <sub>IN</sub> = 3.4V V <sub>IN</sub> = GND	V <sub>IN</sub> = V <sub>CC</sub> V <sub>IN</sub> = GND				
Total Power Supply Current (Note 10)	I <sub>C</sub>	V <sub>CC</sub> = Max, Outputs Open f <sub>I</sub> = 2.5MHz, 50% Duty Cycle E or OE = GND Four Bits Toggling	V <sub>IN</sub> = V <sub>CC</sub> V <sub>IN</sub> = GND	V <sub>IN</sub> = 3.4V V <sub>IN</sub> = GND	V <sub>IN</sub> = V <sub>CC</sub> V <sub>IN</sub> = GND	-	1.5	3.5 (Note 9)	mA
						-	1.8	4.5 (Note 9)	
Total Power Supply Current (Note 10)	I <sub>C</sub>	V <sub>CC</sub> = Max, Outputs Open f <sub>I</sub> = 2.5MHz, 50% Duty Cycle E or OE = GND Four Bits Toggling	V <sub>IN</sub> = V <sub>CC</sub> V <sub>IN</sub> = GND	V <sub>IN</sub> = 3.4V V <sub>IN</sub> = GND	V <sub>IN</sub> = V <sub>CC</sub> V <sub>IN</sub> = GND	-	1.5	3.5 (Note 9)	mA
						-	2.5	7.5 (Note 9)	

## Switching Specifications Over Operating Range

PARAMETER	SYMBOL	(NOTE 11) TEST CONDITIONS	T		AT		CT		(CD74FCT157T ONLY) DT		UNITS
			(NOTE 12) MIN	MAX	(NOTE 12) MIN	MAX	(NOTE 12) MIN	MAX	(NOTE 12) MIN	MAX	
<b>CD74FCT157T, CD74FCT2157T</b>											
Propagation Delay In to Z <sub>N</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF R <sub>L</sub> = 500Ω	1.5	6.0	1.5	5.0	1.5	4.3	1.5	3.9	ns
Propagation Delay E to Z <sub>N</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>		1.5	10.5	1.5	6.0	1.5	4.8	1.5	4.4	ns
Propagation Delay S to Z <sub>N</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>		1.5	10.5	1.5	7.0	1.5	5.2	1.5	4.6	ns
<b>CD74FCT257T, CD74FCT2257T</b>											
Propagation Delay In to Z <sub>N</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF R <sub>L</sub> = 500Ω	1.5	6.0	1.5	5.0	1.5	4.3	-	-	ns
Propagation Delay S to Z <sub>N</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>		1.5	10.5	1.5	7.0	1.5	5.2	-	-	ns
Output Enable Time OE to Z <sub>N</sub>	t <sub>PZH</sub> , t <sub>PZL</sub>		1.5	8.5	1.5	7.0	1.5	6.0	-	-	ns
Output Disable Time OE to Z <sub>N</sub> (Note 13)	t <sub>PZH</sub> , t <sub>PZL</sub>		1.5	6.0	1.5	5.5	1.5	5.0	-	-	ns

### NOTES:

3. For conditions shown as Max or Min, use appropriate value specified under Electrical Specifications for the applicable device type.
4. Typical values are at V<sub>CC</sub> = 5.0V, 25°C ambient and maximum loading.
5. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
6. This parameter is determined by device characterization but is not production tested.
7. Per TTL driven input (V<sub>IN</sub> = 3.4V); all other inputs at V<sub>CC</sub> or GND.
8. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
9. Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are guaranteed but not tested.
10. I<sub>C</sub> = I<sub>QUIESCENT</sub> + I<sub>INPUTS</sub> + I<sub>DYNAMIC</sub>  

$$I_C = I_{CC} + \Delta I_{CC} D_H N_T + I_{CCD} (f_{CP}/2 + f_{NI})$$

$$I_{CC} = \text{Quiescent Current}$$

$$\Delta I_{CC} = \text{Power Supply Current for a TTL High Input (V}_IN = 3.4V)$$

$$D_H = \text{Duty Cycle for TTL Inputs High}$$

$$N_T = \text{Number of TTL Inputs at D}_H$$

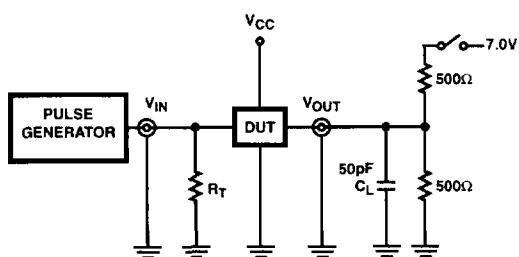
$$I_{CCD} = \text{Dynamic Current Caused by an Input Transition Pair (HLH or LHL)}$$

$$f_{CP} = \text{Clock Frequency for Register Devices (Zero for Non-Register Devices)}$$

$$f_I = \text{Input Frequency}$$

$$N_I = \text{Number of Inputs at } f_I$$

All currents are in millamps and all frequencies are in megahertz.
11. See test circuit and wave forms.
12. Minimum limits are guaranteed but not tested on Propagation Delays.
13. This parameter is guaranteed but not production tested.

**Test Circuits and Waveforms**

SWITCH POSITION	
TEST	SWITCH
$t_{PLZ}, t_{PZL}$	Closed
$t_{PHZ}, t_{PZH}, t_{PLH}, t_{PHL}$	Open

## DEFINITIONS:

$C_L$  = Load capacitance, includes jig and probe capacitance.

$R_T$  = Termination resistance, should be equal to  $Z_{OUT}$  of the Pulse Generator.

## NOTE:

14. Pulse Generator for All Pulses: Rate  $\leq 1.0\text{MHz}$ ;  $Z_{OUT} \leq 50\Omega$ ;  
 $t_f, t_r \leq 2.5\text{ns}$ .

FIGURE 1. TEST CIRCUIT

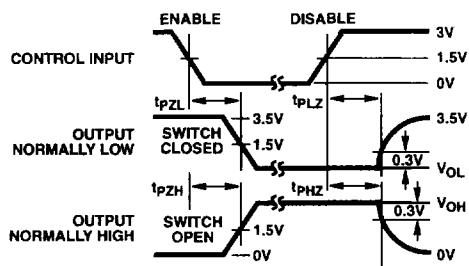


FIGURE 2. ENABLE AND DISABLE TIMING

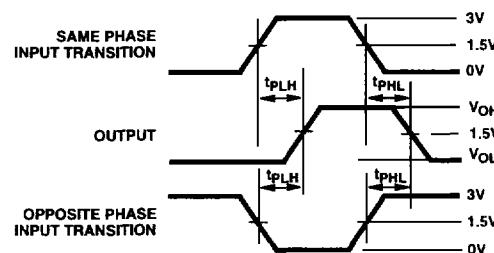


FIGURE 3. PROPAGATION DELAY